NICHIA CORPORATION

SPECIFICATIONS FOR UV LED

NSHU591C

- Built-in ESD Protection Device
- RoHS Compliant
## SPECIFICATIONS

### (1) Absolute Maximum Ratings

<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Absolute Maximum Rating</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>U365</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Forward Current</td>
<td>$I_F$</td>
<td>25</td>
<td>mA</td>
</tr>
<tr>
<td>Pulse Forward Current</td>
<td>$I_{FP}$</td>
<td>80</td>
<td>mA</td>
</tr>
<tr>
<td>Power Dissipation</td>
<td>$P_D$</td>
<td>103</td>
<td>mW</td>
</tr>
<tr>
<td>Junction Temperature</td>
<td>$T_J$</td>
<td>100</td>
<td>°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>U375</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Forward Current</td>
<td>$I_F$</td>
<td>25</td>
<td>mA</td>
</tr>
<tr>
<td>Pulse Forward Current</td>
<td>$I_{FP}$</td>
<td>80</td>
<td>mA</td>
</tr>
<tr>
<td>Power Dissipation</td>
<td>$P_D$</td>
<td>104</td>
<td>mW</td>
</tr>
<tr>
<td>Junction Temperature</td>
<td>$T_J$</td>
<td>100</td>
<td>°C</td>
</tr>
</tbody>
</table>

- Allowable Reverse Current, $I_R$, 85 mA
- Operating Temperature, $T_{opr}$, -30~85 °C
- Storage Temperature, $T_{stg}$, -40~100 °C

* Absolute Maximum Ratings at $T_A=25^\circ$C.
* $I_{FP}$ conditions with pulse width ≤10ms and duty cycle ≤10%.

### (2) Initial Electrical/Optical Characteristics

<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Condition</th>
<th>Typ</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>U365</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Forward Voltage</td>
<td>$V_F$</td>
<td>$I_F=20mA$</td>
<td>3.4</td>
<td>V</td>
</tr>
<tr>
<td>Radiant Flux</td>
<td>$\Phi_e$</td>
<td>$I_F=20mA$</td>
<td>4.0</td>
<td>mW</td>
</tr>
<tr>
<td>Peak Wavelength</td>
<td>$\lambda_p$</td>
<td>$I_F=20mA$</td>
<td>365</td>
<td>nm</td>
</tr>
<tr>
<td>Spectrum Half Width</td>
<td>$\Delta \lambda$</td>
<td>$I_F=20mA$</td>
<td>12</td>
<td>nm</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>U375</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Forward Voltage</td>
<td>$V_F$</td>
<td>$I_F=20mA$</td>
<td>3.3</td>
<td>V</td>
</tr>
<tr>
<td>Radiant Flux</td>
<td>$\Phi_e$</td>
<td>$I_F=20mA$</td>
<td>9.0</td>
<td>mW</td>
</tr>
<tr>
<td>Peak Wavelength</td>
<td>$\lambda_p$</td>
<td>$I_F=20mA$</td>
<td>375</td>
<td>nm</td>
</tr>
<tr>
<td>Spectrum Half Width</td>
<td>$\Delta \lambda$</td>
<td>$I_F=20mA$</td>
<td>9.0</td>
<td>nm</td>
</tr>
</tbody>
</table>

* Characteristics at $T_A=25^\circ$C.
* Radiant Flux value as per CIE 127:2007 standard.
* It is recommended to operate the LEDs at a current greater than 10% of the sorting current to stabilize the LED characteristics.
### RANKS

<table>
<thead>
<tr>
<th>Item</th>
<th>Rank</th>
<th>Min</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Forward Voltage</td>
<td>-</td>
<td>2.9</td>
<td>4.0</td>
<td>V</td>
</tr>
<tr>
<td>Radiant Flux</td>
<td>8e</td>
<td>9.44</td>
<td>13.32</td>
<td>mW</td>
</tr>
<tr>
<td></td>
<td>7e</td>
<td>6.66</td>
<td>9.44</td>
<td></td>
</tr>
<tr>
<td></td>
<td>6e</td>
<td>4.72</td>
<td>6.66</td>
<td></td>
</tr>
<tr>
<td></td>
<td>7</td>
<td>5.34</td>
<td>7.56</td>
<td></td>
</tr>
<tr>
<td></td>
<td>6</td>
<td>3.78</td>
<td>5.34</td>
<td></td>
</tr>
<tr>
<td></td>
<td>5</td>
<td>2.67</td>
<td>3.78</td>
<td></td>
</tr>
<tr>
<td>Peak Wavelength</td>
<td>U375</td>
<td>370</td>
<td>380</td>
<td>nm</td>
</tr>
<tr>
<td></td>
<td>U365</td>
<td>360</td>
<td>370</td>
<td></td>
</tr>
</tbody>
</table>

* Ranking at $T_A=25^\circ C$.
* Forward Voltage Tolerance: ±0.05V
* Radiant Flux Tolerance: ±10%
* Peak Wavelength Tolerance: ±3nm
* LEDs from the above ranks will be shipped. The rank combination ratio per shipment will be decided by Nichia.

#### Radiant Flux Ranks by Peak Wavelength

<table>
<thead>
<tr>
<th>Ranking by Radiant Flux</th>
<th>5</th>
<th>6</th>
<th>7</th>
<th>6e</th>
<th>7e</th>
<th>8e</th>
</tr>
</thead>
<tbody>
<tr>
<td>Ranking by Peak Wavelength</td>
<td>U365</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>U375</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>


OUTLINE DIMENSIONS

* This product complies with RoHS Directive.
* The dimension(s) in parentheses are for reference purposes.

<table>
<thead>
<tr>
<th>Item</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>Glass</td>
<td>Glass Materials</td>
</tr>
<tr>
<td>Cap</td>
<td>Cap Materials</td>
</tr>
<tr>
<td>Lead</td>
<td>Lead Materials</td>
</tr>
<tr>
<td>Weight</td>
<td>Weight</td>
</tr>
</tbody>
</table>

- Glass: Hard Glass
- Cap: Ni-plated Iron Alloy
- Lead: Au-plated Iron Alloy
- Weight: 0.37g (TYP)

管理番号: STS-DA1-5728B (Cat.No.190919)

(単位 Unit: mm, 公差 Tolerance: ±0.2)
SOLDERING

- **Recommended Hand Soldering Condition**
  
<table>
<thead>
<tr>
<th>Temperature</th>
<th>350°C Max</th>
</tr>
</thead>
<tbody>
<tr>
<td>Soldering Time</td>
<td>3sec Max</td>
</tr>
<tr>
<td>Position</td>
<td>No closer than 3mm from the base of the lead.</td>
</tr>
</tbody>
</table>

- **Recommended Dip Soldering Condition**

<table>
<thead>
<tr>
<th>Pre-heat</th>
<th>120°C Max</th>
</tr>
</thead>
<tbody>
<tr>
<td>Pre-heat Time</td>
<td>60sec Max</td>
</tr>
<tr>
<td>Solder Bath Temperature</td>
<td>260°C Max</td>
</tr>
<tr>
<td>Dipping Time</td>
<td>10sec Max</td>
</tr>
<tr>
<td>Dipping Position</td>
<td>No closer than 3mm from the base of the lead.</td>
</tr>
</tbody>
</table>

* Solder the LED no closer than 3mm from the bottom of the lens.
* Dip soldering/hand soldering must not be performed more than once.
* When cooling the LEDs from the peak temperature a gradual cooling slope is recommended; do not cool the LEDs rapidly. Sufficient verification should be performed prior to use to ensure that excess stress is not applied to the LEDs as the LEDs are cooled.
* When soldering, do not apply stress to the lead frame while the LED is hot.
* When using a pick and place machine, choose an appropriate nozzle for this product.
* After soldering, do not correct the LED position.
* After soldering, NO mechanical shock or vibration should be applied to LED cap until the LEDs cool down to room temperature.
* In order to avoid damage on the cap during cutting and clinching the leads, it is not recommended to solder the LEDs directly on customer PCB without any gap between the cap and the board. If it is unavoidable, customer is advised to check whether such soldering will not cause wire breakage or cap damage. Direct soldering to double-sided PCBs must be avoided due to an increased effect of heat on the cap.
* If the LED is clamped during dip soldering to prevent soldering failures (e.g. position shift), ensure that the mechanical stress on the LED is minimized.
* Ensure that the cutting of the lead frames is performed at room temperature. If it is done while the LED is hot, it may cause issues (e.g. damage to the LED).
* Consider factors (e.g. dip soldering temperature, hand soldering temperature, etc.) when choosing the solder.
* When flux is used, it should be a halogen free flux. Ensure that the manufacturing process is not designed in a manner where the flux will come in contact with the LEDs.
Anti-electrostatic bags are packed in cardboard boxes with corrugated partitions.

Products are packed in an anti-electrostatic bag. They are shipped in cardboard boxes to protect them from external forces during transportation.

Do not expose to water. The box is not water-resistant.

Do not drop or expose the box to external forces as it may damage the products.

Taking care to avoid dropping or severe impact, the products may suffer damage.

Do not expose to water. The box is not water-resistant.

Using the original package material or equivalent in transit is recommended.

For details, see "LOT NUMBERING CODE" in this document.

Alternatively, refer to the customer part number for information.

Label attached to the box

UV LED

Part No.: Nxxxxxxx

Lot: YMxxxxx-RRR

QTY.: PCS

Nichia LED

Warning and Explanatory Labels

UV LED

- UV LEDs emit light in the ultraviolet region (UV light).
- Do not expose the eyes directly to the UV light. Wear appropriate protective gear when handling.
- Use appropriate warning signs/labels on devices using the UV LEDs.
**LOT NUMBERING CODE**

Lot Number is presented by using the following alphanumeric code.

YMxxxx - RRR

Y - Year

<table>
<thead>
<tr>
<th>Year</th>
<th>Y</th>
</tr>
</thead>
<tbody>
<tr>
<td>2018</td>
<td>I</td>
</tr>
<tr>
<td>2019</td>
<td>J</td>
</tr>
<tr>
<td>2020</td>
<td>K</td>
</tr>
<tr>
<td>2021</td>
<td>L</td>
</tr>
<tr>
<td>2022</td>
<td>M</td>
</tr>
<tr>
<td>2023</td>
<td>N</td>
</tr>
</tbody>
</table>

M - Month

<table>
<thead>
<tr>
<th>Month</th>
<th>M</th>
<th>Month</th>
<th>M</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>1</td>
<td>7</td>
<td>7</td>
</tr>
<tr>
<td>2</td>
<td>2</td>
<td>8</td>
<td>8</td>
</tr>
<tr>
<td>3</td>
<td>3</td>
<td>9</td>
<td>9</td>
</tr>
<tr>
<td>4</td>
<td>4</td>
<td>10</td>
<td>A</td>
</tr>
<tr>
<td>5</td>
<td>5</td>
<td>11</td>
<td>B</td>
</tr>
<tr>
<td>6</td>
<td>6</td>
<td>12</td>
<td>C</td>
</tr>
</tbody>
</table>

xxxx-Nichia’s Product Number

RRR-Ranking by Wavelength, Ranking by Radiant Flux
DERATING CHARACTERISTICS

Ambient Temperature vs Allowable Forward Current

Duty Ratio vs Allowable Forward Current

Allowable Forward Current (mA)

Ambient Temperature (°C)

Duty Ratio (%)

Allowable Forward Current (mA)

Duty Ratio (%)
OPTICAL CHARACTERISTICS

* All characteristics shown are for reference only and are not guaranteed.

* The graphs above show the characteristics for U365x LEDs of this product.

**Spectrum**

![Spectrum Graph]

**Directivity**

![Directivity Graph]

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* NSHU591C
  No. STS-DA7-15509A

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* The graphs above show the characteristics for U365x LEDs of this product.

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* The graphs above show the characteristics for U365x LEDs of this product.
* All characteristics shown are for reference only and are not guaranteed.

* The graphs above show the characteristics for U375x LEDs of this product.
FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

All characteristics shown are for reference only and are not guaranteed.

* The graphs above show the characteristics for U365x LEDs of this product.

Forward Voltage vs Forward Current
順電圧-順電流特性

Ambient Temperature vs Forward Voltage
周囲温度-順電圧特性

Forward Current vs Relative Radiant Flux
順電流-相対放射束特性

Ambient Temperature vs Relative Radiant Flux
周囲温度-相対放射束特性

* The graphs above show the characteristics for U365x LEDs of this product.

本特性は参考です。
FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

* All characteristics shown are for reference only and are not guaranteed.

* The graphs above show the characteristics for U375x LEDs of this product.

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**Forward Voltage vs Forward Current**

Ambient Temperature vs Forward Voltage

**Relative Radiant Flux vs Forward Current**

Ambient Temperature vs Relative Radiant Flux

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* NSHU591C (Cat.No.190919)
  No. STS-DA7-15512A
* All characteristics shown are for reference only and are not guaranteed.

The graphs above show the characteristics for U365x LEDs of this product.
* All characteristics shown are for reference only and are not guaranteed.

Forward Current vs Peak Wavelength

Ambient Temperature vs Peak Wavelength

* The graphs above show the characteristics for U375x LEDs of this product.

本特性は参考です。
### RELIABILITY

(1) Tests and Results

<table>
<thead>
<tr>
<th>Test</th>
<th>Reference Standard</th>
<th>Test Conditions</th>
<th>Test Duration</th>
<th>Failure Criteria</th>
<th>Units Failed/Tested</th>
</tr>
</thead>
<tbody>
<tr>
<td>Resistance to Soldering Heat</td>
<td>JEITA ED-4701 300 302</td>
<td>$T_{id}=260±5^\circ\text{C}, 10\text{sec, 1dip, 3mm from the base of the lead}$</td>
<td></td>
<td>#1</td>
<td>0/22</td>
</tr>
<tr>
<td>Solderability</td>
<td>JEITA ED-4701 303 303A</td>
<td>$T_{id}=245±5^\circ\text{C}, 5\text{sec, Lead-free Solder(Sn-3.0Ag-0.5Cu)}$</td>
<td></td>
<td>#2</td>
<td>0/22</td>
</tr>
<tr>
<td>Thermal Shock (Air to Air)</td>
<td>JEITA ED-4701 200 203</td>
<td>-40°C to 100°C, 15min dwell</td>
<td>100cycles</td>
<td>#1</td>
<td>0/22</td>
</tr>
<tr>
<td>Moisture Resistance (Cyclic)</td>
<td>JEITA ED-4701 200 203</td>
<td>25°C<del>65°C</del>10°C, 90%RH, 24hr per cycle</td>
<td>10cycles</td>
<td>#1</td>
<td>0/22</td>
</tr>
<tr>
<td>Terminal Bend Strength</td>
<td>JEITA ED-4701 400 401</td>
<td>5N, 0°~90°~0°bend, 2bending cycles</td>
<td></td>
<td>#1</td>
<td>0/22</td>
</tr>
<tr>
<td>Terminal Pull Strength</td>
<td>JEITA ED-4701 400 401</td>
<td>10N, 10±1sec</td>
<td></td>
<td>#1</td>
<td>0/22</td>
</tr>
<tr>
<td>High Temperature Storage</td>
<td>JEITA ED-4701 200 201</td>
<td>$T_A=100^\circ\text{C}$</td>
<td>1000hours</td>
<td>#1</td>
<td>0/22</td>
</tr>
<tr>
<td>Temperature Humidity Storage</td>
<td>JEITA ED-4701 100 103</td>
<td>$T_A=60^\circ\text{C, RH=90%}$</td>
<td>1000hours</td>
<td>#1</td>
<td>0/22</td>
</tr>
<tr>
<td>Low Temperature Storage</td>
<td>JEITA ED-4701 200 202</td>
<td>$T_A=-40^\circ\text{C}$</td>
<td>1000hours</td>
<td>#1</td>
<td>0/22</td>
</tr>
<tr>
<td>Room Temperature Operating Life</td>
<td></td>
<td>$T_A=25^\circ\text{C, I}_f=25\text{mA}$</td>
<td>500hours</td>
<td>#1</td>
<td>0/22</td>
</tr>
<tr>
<td>Temperature Humidity Operating Life</td>
<td></td>
<td>$60^\circ\text{C, RH=90%, I}_f=15\text{mA}$</td>
<td>500hours</td>
<td>#1</td>
<td>0/22</td>
</tr>
<tr>
<td>Low Temperature Operating Life</td>
<td></td>
<td>$T_A=-30^\circ\text{C, I}_f=20\text{mA}$</td>
<td>1000hours</td>
<td>#1</td>
<td>0/22</td>
</tr>
</tbody>
</table>

**NOTES:**
Measurements are performed after allowing the LEDs to return to room temperature.

(2) Failure Criteria

<table>
<thead>
<tr>
<th>Criteria #</th>
<th>Items</th>
<th>Conditions</th>
<th>Failure Criteria</th>
</tr>
</thead>
<tbody>
<tr>
<td>#1</td>
<td>Forward Voltage($V_f$)</td>
<td>$I_f=20\text{mA}$</td>
<td>$&gt;\text{U.S.L.} \times 1.1$</td>
</tr>
<tr>
<td></td>
<td>Radiant Flux($\Phi_E$)</td>
<td>$I_f=20\text{mA}$</td>
<td>$&lt;\text{L.S.L.} \times 0.7$</td>
</tr>
<tr>
<td>#2</td>
<td>Solderability</td>
<td>-</td>
<td>Less than 95% solder coverage</td>
</tr>
</tbody>
</table>

CAUTIONS

(1) Lead Forming

- The lead frame should be bent at least 3mm from the bottom of the lens. Do not use the bottom of the lens as a fulcrum for bending.
- Lead frame forming (i.e. shaping/trimming the lead frame) should be done before soldering the LED; if it is done after soldering, Nichia will not guarantee its reliability.
- When shaping/trimming the lead frame, ensure that the resulting stress is not applied to the bottom of the lens. This may damage the characteristics of the LED.
- If the LEDs are attached to a PCB or any other substrate (e.g. plastic plate), ensure that the hole on the substrate matches with the lead frame dimensions (e.g. pitch). Otherwise, it may cause the lens to deform causing reliability issues (e.g. the LED to have a reduction in the radiant flux or not to illuminate [i.e. catastrophic failure]).

(2) Storage

- Before opening the anti-electrostatic bag, ensure that LEDs are stored at <30°C and 70% RH and used within three months. To store these LEDs after this period, use a hermetically-sealed container filled with nitrogen and place silica gel desiccants in this container with the LEDs; the LEDs must not be stored for longer than one year from the date that the LED is delivered.
- This LED has a gold-plated lead frame. If the LEDs are exposed to a corrosive environment, it may cause the plated surface to tarnish causing issues (i.e. solderability). Ensure that LEDs are stored under proper conditions/environment and soldered to a PCB immediately.
- To avoid condensation, the products must not be stored in the areas where temperature and humidity fluctuate greatly.
- Do not store the LEDs in a dusty environment.
- Do not expose the LEDs to direct sunlight and/or an environment over a long period of time where the temperature is higher than normal room temperature.

(3) Directions for Use

- The circuit must be designed to ensure that the Absolute Maximum Ratings are not exceeded for each LED. The LEDs should be operated at a constant current per LED. In the case of operating at a constant voltage, Circuit B is recommended. If Circuit A is used, it may cause the currents flowing through the LEDs to vary due to the variation in the forward voltage characteristics of the LEDs on the circuit.

\[
\text{(A)} \quad \begin{array}{c}
\text{LED} \\
\text{LED} \\
\text{LED} \\
\text{LED} \\
\text{LED} \\
\end{array}
\quad \begin{array}{c}
\text{LED} \\
\text{LED} \\
\text{LED} \\
\text{LED} \\
\text{LED} \\
\end{array}
\quad \begin{array}{c}
\text{LED} \\
\text{LED} \\
\text{LED} \\
\text{LED} \\
\text{LED} \\
\end{array}
\]

\[
\text{(B)} \quad \begin{array}{c}
\text{LED} \\
\text{LED} \\
\text{LED} \\
\text{LED} \\
\text{LED} \\
\end{array}
\quad \begin{array}{c}
\text{LED} \\
\text{LED} \\
\text{LED} \\
\text{LED} \\
\text{LED} \\
\end{array}
\quad \begin{array}{c}
\text{LED} \\
\text{LED} \\
\text{LED} \\
\text{LED} \\
\text{LED} \\
\end{array}
\]

- This LED is designed to be operated at a forward current. Ensure that no voltage is applied to the LED in the forward/reverse direction while the LED is off. If the LEDs are used in an environment where reverse voltages are applied to the LED continuously, it may cause electrochemical migration to occur causing the LED to be damaged. When not in use for a long period of time, the system’s power should be turned off to ensure that there are no issues/damage.
- To stabilize the LED characteristics while in use, Nichia recommends that the LEDs are operated at currents ≥ 10% of the sorting current.
- Ensure that transient excessive voltages (e.g. lightning surge) are not applied to the LEDs.
- If the LEDs are used for outdoor applications, ensure that necessary measures are taken (e.g. protecting the LEDs from water/salt damage and high humidity).
- Although this LED is specifically designed to emit invisible light, a small amount of light in the visible region exists in the emission spectrum. Ensure that when using the LEDs for sensors, verification is performed to ensure that the emission spectrum is fit for the intended use.
- Do not design this LED into applications where condensation may occur. If the LEDs are stored/operated in these environments, it may cause issues (e.g. current leaks that cause the radiant flux to decrease).
(4) Handling Precautions

- Do not handle the LEDs with bare hands:
  - this may contaminate the LED surface and have an effect on the optical characteristics,
  - this may cause the LED to deform and/or the wire to break causing a catastrophic failure (i.e. the LED not to illuminate),
  - the lead frame may cause injuries when the LED is handled with bare hands.
- Dropping may cause damage to the LED (e.g. deformation).
- Do not stack assembled PCBs together. Otherwise, it may cause damage to the lens (e.g. cut, scratch, chip, crack, delamination and deformation) and the wire to break causing a catastrophic failure (i.e. the LED not to illuminate).

(5) Design Consideration

- If the LEDs are soldered to a PCB and the PCB assembly is bent (e.g. PCB depaneling process), it may cause the LED package to break. The PCB layout should be designed to minimize the mechanical stress on the LEDs when the PCB assembly is bent/warped.
- The amount of mechanical stress exerted on the LED from depaneling may vary depending on the LED position/orientation on the PCB assembly (e.g. especially in areas near V-groove scores). The PCB layout should be designed to minimize the mechanical stress on the LEDs when the PCB is separated into individual PCB assemblies.
- To separate a PCB populated with the LEDs, use a specially designed tool. Do not break the PCB by hand.
- Volatile organic compounds that have been released from materials present around the LEDs (e.g. housing, gasket/seal, adhesive, secondary lens, lens cover, thermal grease, etc.) may adhere to the LED glass cover and other areas (e.g. package). If the LEDs are being used in a hermetically sealed environment, these volatile compounds can discolor after being exposed to heat and/or photon energy and it may greatly reduce the LED light output. In this case, ventilating the environment may improve the reduction in light output. Perform a light-up test of the chosen application for optical evaluation to ensure that there are no issues.

(6) Electrostatic Discharge (ESD)

- This LED is sensitive to transient excessive voltages (e.g. ESD, lightning surge). If this excessive voltage occurs in the circuit, it may cause the LED to be damaged causing issues (e.g. the LED to have a reduction in the radiant flux or not to illuminate [i.e. catastrophic failure]).
  - Ensure that when handling the LEDs, necessary measures are taken to protect them from an ESD discharge. The following examples are recommended measures to eliminate the charge:
    - Grounded wrist strap, ESD footwear, clothes, and floors
    - Grounded workstation equipment and tools
    - ESD table/shelf mat made of conductive materials
  - Ensure that all necessary measures are taken to prevent the LEDs from being exposed to transient excessive voltages (e.g. ESD, lightning surge):
    - tools (e.g. soldering irons), jigs, and machines that are used are properly grounded
    - appropriate ESD materials/equipment are used in the work area
    - the system/assembly is designed to provide ESD protection for the LEDs.
- If the tool/equipment used is an insulator (e.g. glass cover, plastic, etc.), ensure that necessary measures have been taken to protect the LED from transient excessive voltages (e.g. ESD). The following examples are recommended measures to eliminate the charge:
  - Dissipating static charge with conductive materials
  - Preventing charge generation with moisture
  - Neutralizing the charge with ionizers
- To detect if an LED was damaged by transient excess voltages (i.e. an ESD event during the system’s assembly process), perform a characteristics inspection (e.g. forward voltage measurement) at low current (≤1mA).
- Failure Criteria: $V_F<2.0V$ at $I_F=0.5mA$
  - If the LED is damaged by transient excess voltages (e.g. ESD), it will cause the Forward Voltage ($V_F$) to decrease.

(7) Thermal Management

- The Absolute Maximum Junction Temperature ($T_J$) must not be exceeded under any circumstances. The increase in the temperature of an LED while in operation may vary depending on the PCB thermal resistance and the density of LEDs on the PCB assembly. Ensure that when using the LEDs for the chosen application, heat is not concentrated in an area and properly managed in the system/assembly.
- The operating current should be determined by considering the temperature conditions surrounding the LED (i.e. $T_A$). Ensure that when operating the LED, proper measures are taken to dissipate the heat.
(8) Cleaning

- Do not clean the LEDs with water, benzine and/or thinner.
- To clean the LEDs, use isopropyl alcohol (IPA). If another solvent is used, it may cause the LED package/resin to be damaged causing issues; ensure that sufficient verification is performed prior to use. Additionally, ensure that the solvent being used does not cause any other issues (e.g. CFC-based solvents are heavily regulated).
- If an LED is contaminated (e.g. dust/dirt), use a cloth soaked with isopropyl alcohol (IPA). Ensure that the cloth is firmly squeezed before wiping the LED.
- Do not clean the LEDs with an ultrasonic cleaner. If cleaning must be done, ensure that sufficient verification is performed by using a finished assembly with LEDs to determine cleaning conditions (e.g. ultrasonic power, LED position on the PCB assembly) that do not cause an issue.

(9) Eye Safety

- There may be two important international specifications that should be noted for safe use of the LEDs: IEC 62471:2006 Photobiological safety of lamps and lamp systems and IEC 60825-1:2001 (i.e. Edition 1.2) Safety of Laser Products - Part 1: Equipment Classification and Requirements. Ensure that when using the LEDs, there are no issues with the following points:
  - LEDs have been removed from the scope of IEC 60825-1 since IEC 60825-1:2007 (i.e. Edition 2.0) was published. However, depending on the country/region, there are cases where the requirements of the IEC 60825-1:2001 specifications or equivalent must be adhered to.
  - LEDs have been included in the scope of IEC 62471:2006 since the release of the specification in 2006.
  - Most Nichia LEDs will be classified as the Exempt Group or Risk Group 1 according to IEC 62471:2006. However, in the case of high-power LEDs containing blue wavelengths in the emission spectrum, there are LEDs that will be classified as Risk Group 2 depending on the characteristics (e.g. radiation flux, emission spectrum, directivity, etc.)
  - If the LED is used in a manner that produces an increased output or with an optic to collimate the light from the LED, it may cause damage to the human eye.
- If an LED is operated in a manner that emits a flashing light, it may cause health issues (e.g. visual stimuli causing eye discomfort). The system should be designed to ensure that there are no harmful effects on the human body.
- This LED emits light in the ultraviolet (UV) region. The UV light from an LED while in operation is intense and harmful; if human eyes are exposed to this light, it may cause damage to them. Do not look directly or indirectly (e.g. through an optic) at the UV light. Ensure that if there is a possibility that the UV light reflects off objects and enters the eyes, appropriate protection gear (e.g. goggles) is used to prevent the eyes from being exposed to the light.
- Ensure that appropriate warning signs/labels are provided both on each of the systems/applications using the UV LEDs, in all necessary documents (e.g. specification, manual, catalogs, etc.), and on the packaging materials.
(10) Miscellaneous

- Nichia warrants that the discrete LEDs will meet the requirements/criteria as detailed in the Reliability section within this specification. If the LEDs are used under conditions/environments deviating from or inconsistent with those described in this specification, the resulting damage and/or injuries will not be covered by this warranty.
- Nichia warrants that the discrete LEDs manufactured and/or supplied by Nichia will meet the requirements/criteria as detailed in the Reliability section within this specification; it is the customer’s responsibility to perform sufficient verification prior to use to ensure that the lifetime and other quality characteristics required for the intended use are met.
- The applicable warranty period is one year from the date that the LED is delivered. In the case of any incident that appears to be in breach of this warranty, the local Nichia sales representative should be notified to discuss instructions on how to proceed while ensuring that the LED in question is not disassembled or removed from the PCB if it has been attached to the PCB. If a breach of this warranty is proved, Nichia will provide the replacement for the non-conforming LED or an equivalent item at Nichia’s discretion. FOREGOING ARE THE EXCLUSIVE REMEDIES AVAILABLE TO THE CUSTOMER IN RESPECT OF THE BREACH OF THE WARRANTY CONTAINED HEREIN, AND IN NO EVENT SHALL NICHIA BE RESPONSIBLE FOR ANY INDIRECT, INCIDENTAL OR CONSEQUENTIAL LOSSES AND/OR EXPENSES (INCLUDING LOSS OF PROFIT) THAT MAY BE SUFFERED BY THE CUSTOMER ARISING OUT OF A BREACH OF THE WARRANTY.
- NICHIA DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, INCLUDING THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE.
- This LED is intended to be used for general lighting, household appliances, electronic devices (e.g. mobile communication devices); it is not designed or manufactured for use in applications that require safety critical functions (e.g. aircraft, automobiles, combustion equipment, life support systems, nuclear reactor control system, safety devices, spacecraft, submarine repeaters, traffic control equipment, trains, vessels, etc.). If the LEDs are planned to be used for these applications, unless otherwise detailed in the specification, Nichia will neither guarantee that the LED is fit for that purpose nor be responsible for any resulting property damage, injuries and/or loss of life/health. This LED does not comply with IATF 16949 and is not intended for automotive applications.
- The customer will not reverse engineer, disassemble or otherwise attempt to extract knowledge/design information from the LED.
- All copyrights and other intellectual property rights in this specification in any form are reserved by Nichia or the right holders who have granted Nichia permission to use the content. Without prior written permission from Nichia, no part of this specification may be reproduced in any form or by any means.
- Both the customer and Nichia will agree on the official specifications for the supplied LEDs before any programs are officially launched. Without this agreement in writing (i.e. Customer Specific Specification), changes to the content of this specification may occur without notice (e.g. changes to the foregoing specifications and appearance, discontinuation of the LEDs, etc.).